# LNJ406K54RX

### Hight Bright Surface Mounting Chip LED

S-J Type

#### ■ Absolute Maximum Ratings $T_a = 25$ °C

| Parameter                     | Symbol           | Rating      | Unit |  |
|-------------------------------|------------------|-------------|------|--|
| Power dissipation             | $P_{\mathrm{D}}$ | 50          | mW   |  |
| Forward current               | $I_{\mathrm{F}}$ | 20          | mA   |  |
| Pulse forward current *       | $I_{FP}$         | 60          | mA   |  |
| Reverse voltage               | V <sub>R</sub>   | 4           | V    |  |
| Operating ambient temperature | T <sub>opr</sub> | -25 to +85  | °C   |  |
| Storage temperature           | T <sub>stg</sub> | -30 to +100 | °C   |  |

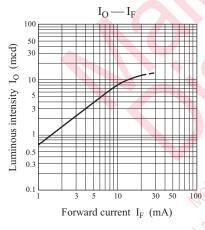
Note) \*: The condition of I<sub>FP</sub> is duty 10%, Pulse width 1 msec.

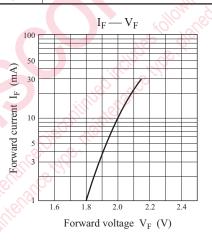
### ■ Lighting Color

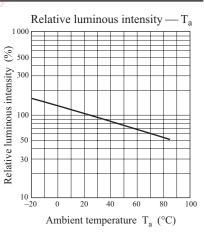
Amber

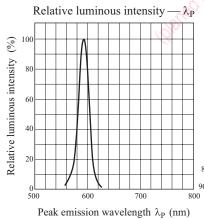
#### ■ Electro-Optical Characteristics $T_a = 25$ °C

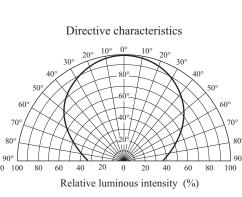
|                          |                        |                       |         |      | 0   |      |
|--------------------------|------------------------|-----------------------|---------|------|-----|------|
| Parameter                | Symbol                 | Conditions            | Min     | Тур  | Max | Unit |
| Luminous intensity       | $I_{O}$                | $I_F = 10 \text{ mA}$ | 3.5     | 8.5  | 100 | mcd  |
| Reverse current          | $I_R$                  | $V_R = 4 V$           | 1,10    | 1160 | 100 | μА   |
| Forward voltage          | V <sub>F</sub>         | $I_F = 10 \text{ mA}$ |         | 2.0  | 2.3 | V    |
| Peak emission wavelength | $\lambda_{\mathrm{P}}$ | $I_F = 10 \text{ mA}$ | i dillo | 595  |     | nm   |
| Spectral half band width | Δλ                     | $I_F = 10 \text{ mA}$ | 80.     | 15   |     | nm   |

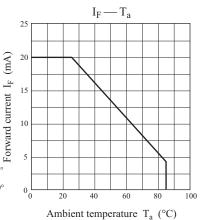








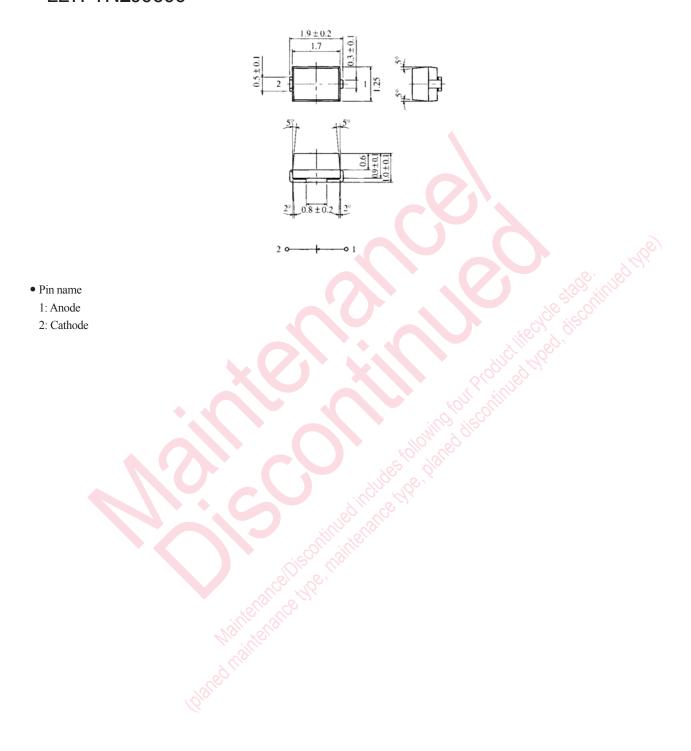




LNJ406K54RX Panasonic

■ Package (Unit: mm)

## LLTFTN2J0600



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